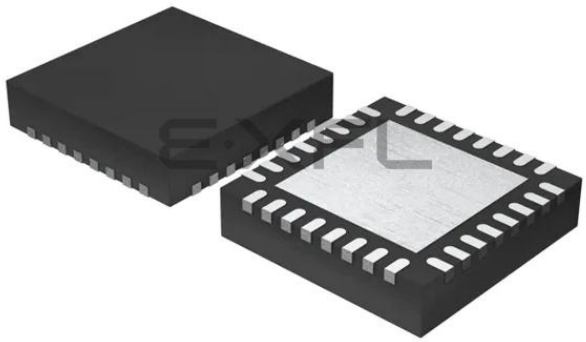

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	25
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.25V
Data Converters	A/D 25x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VFQFN Exposed Pad
Supplier Device Package	32-QFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f563-imr

1. System Overview

C8051F55x/56x/57x devices are fully integrated mixed-signal System-on-a-Chip MCUs. Highlighted features are listed below. Refer to Table 2.1 for specific product feature selection and part ordering numbers.

- High-speed pipelined 8051-compatible microcontroller core (up to 50 MIPS)
- In-system, full-speed, non-intrusive debug interface (on-chip)
- Controller Area Network (CAN 2.0B) Controller with 32 message objects, each with its own indentifier mask (C8051F550/1/4/5, ‘F560/1/4/5/8/9, and ‘F572/3)
- LIN 2.1 peripheral (fully backwards compatible, master and slave modes) (C8051F550/2/4/6, ‘F560/2/4/6/8, and ‘F570/2/4)
- True 12-bit 200 ksps 32-channel single-ended ADC with analog multiplexer
- Precision programmable 24 MHz internal oscillator that is within ±0.5% across the temperature range and for VDD voltages greater than or equal to the on-chip voltage regulator minimum output at the low setting. The oscillator is within ±1.0% for VDD voltages below this minimum output setting.
- On-chip Clock Multiplier to reach up to 50 MHz
- 32 kB (C8051F550-3, ‘F560-3, ‘F568-9, and ‘F570-1) or 16 kB (C8051F554-7, ‘F564-7, and ‘F572-5) of on-chip Flash memory
- 2304 bytes of on-chip RAM
- SMBus/I2C, Enhanced UART, and Enhanced SPI serial interfaces implemented in hardware
- Four general-purpose 16-bit timers
- External Data Memory Interface (C8051F568-9 and ‘F570-5) with 64 kB address space
- Programmable Counter/Timer Array (PCA) with six capture/compare modules and Watchdog Timer function
- On-chip Voltage Regulator
- On-chip Power-On Reset, V_{DD} Monitor, and Temperature Sensor
- On-chip Voltage Comparator
- 33, 25, or 18 Port I/O (5 V push-pull)

With on-chip Voltage Regulator, Power-On Reset, V_{DD} monitor, Watchdog Timer, and clock oscillator, the C8051F55x/56x/57x devices are truly stand-alone System-on-a-Chip solutions. The Flash memory can be reprogrammed even in-circuit, providing non-volatile data storage, and also allowing field upgrades of the 8051 firmware. User software has complete control of all peripherals, and may individually shut down any or all peripherals for power savings.

The on-chip Silicon Labs 2-Wire (C2) Development Interface allows non-intrusive (uses no on-chip resources), full speed, in-circuit debugging using the production MCU installed in the final application. This debug logic supports inspection and modification of memory and registers, setting breakpoints, single stepping, run and halt commands. All analog and digital peripherals are fully functional while debugging using C2. The two C2 interface pins can be shared with user functions, allowing in-system debugging without occupying package pins.

The devices are specified for 1.8 V to 5.25 V operation over the automotive temperature range (–40 to +125 °C). The C8051F568-9 and ‘F570-5 are available in 40-pin QFN packages, the C8051F560-7 devices are available in 32-pin QFP and QFN packages, and the C8051F550-7 are available in 24-pin QFN packages. All package options are lead-free and RoHS compliant. See Table 2.1 for ordering information. Block diagrams are included in Figure 1.1, Figure 1.2, and Figure 1.3.

4. Package Specifications

4.1. QFN-40 Package Specifications

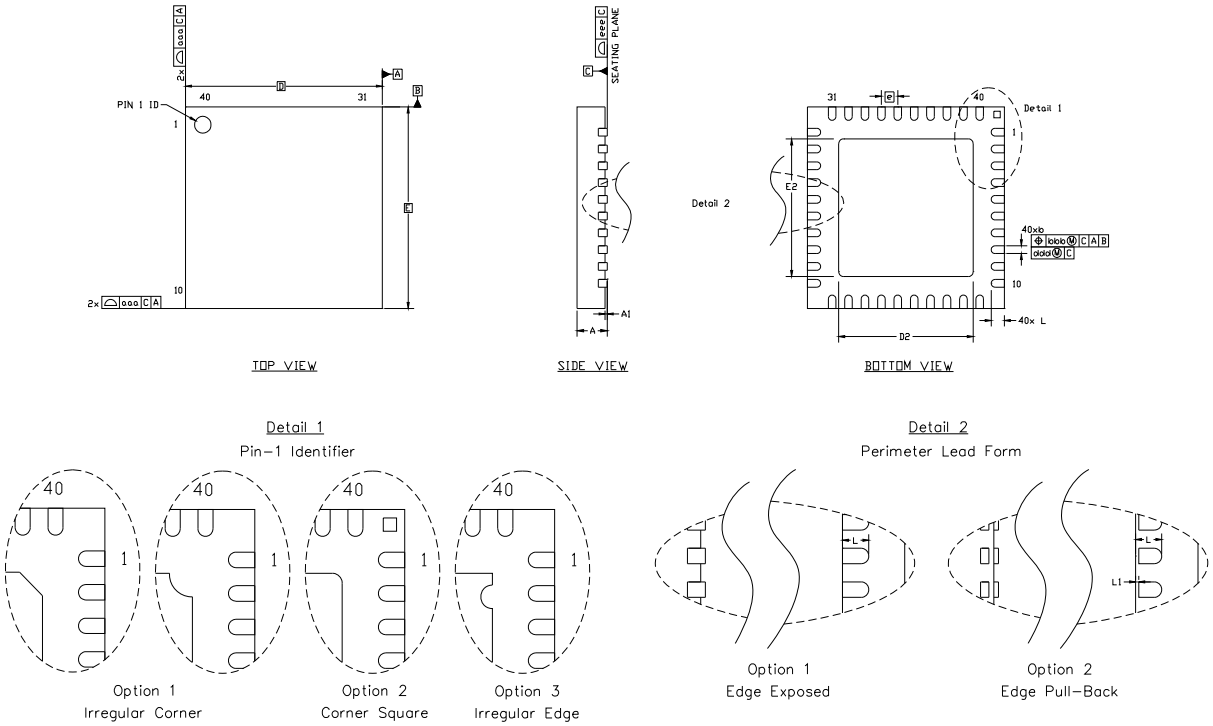

Figure 4.1. QFN-40 Package Drawing

Table 4.1. QFN-40 Package Dimensions

Dimension	Min	Typ	Max
A	0.80	0.85	0.90
A1	0.00		0.05
b	0.18	0.23	0.28
D		6.00 BSC	
D2	4.00	4.10	4.20
e		0.50 BSC	
E		6.00 BSC	

Dimension	Min	Typ	Max
E2	4.00	4.10	4.20
L	0.35	0.40	0.45
L1			0.10
aaa			0.10
bbb			0.10
ddd			0.05
eee			0.08

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to JEDEC Solid State Outline MO-220, variation VJJD-5, except for features A, D2, and E2 which are toleranced per supplier designation.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

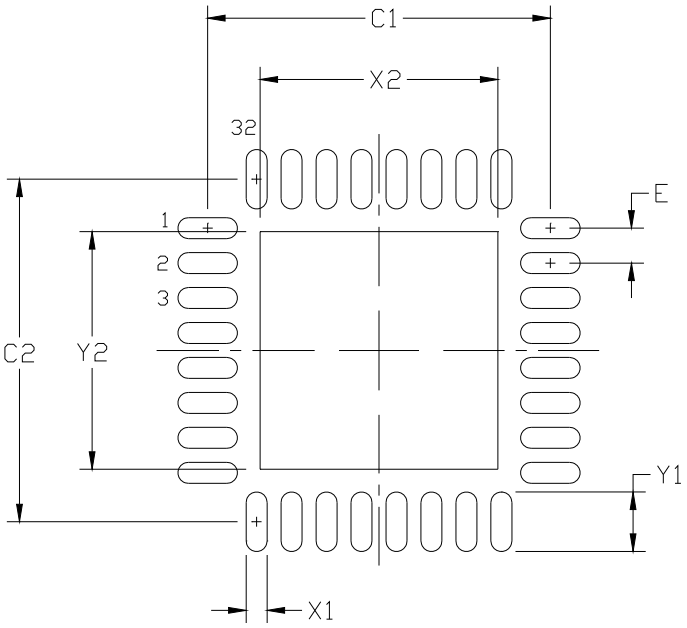

Figure 4.6. QFN-32 Landing Diagram

Table 4.6. QFN-32 Landing Diagram Dimensions

Dimension	Min	Max		Dimension	Min	Max
C1	4.80	4.90		X2	3.20	3.40
C2	4.80	4.90		Y1	0.75	0.85
e	0.50 BSC			Y2	3.20	3.40
X1	0.20	0.30				

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
5. The stencil thickness should be 0.125 mm (5 mils).
6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
7. A 3x3 array of 1.0 mm openings on a 1.20 mm pitch should be used for the center ground pad.

Card Assembly

8. A No-Clean, Type-3 solder paste is recommended.
9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

6.3.2. Setting the Gain Value

The three programmable gain registers are accessed indirectly using the ADC0H and ADC0L registers when the GAINEN bit (ADC0CF.0) bit is set. ADC0H acts as the address register, and ADC0L is the data register. The programmable gain registers can only be written to and cannot be read. See Gain Register Definition 6.1, Gain Register Definition 6.2, and Gain Register Definition 6.3 for more information.

The gain is programmed using the following steps:

1. Set the GAINEN bit (ADC0CF.0)
2. Load the ADC0H with the ADC0GNH, ADC0GNL, or ADC0GNA address.
3. Load ADC0L with the desired value for the selected gain register.
4. Reset the GAINEN bit (ADC0CF.0)

Notes:

1. An ADC conversion should not be performed while the GAINEN bit is set.
2. Even with gain enabled, the maximum input voltage must be less than V_{REGIN} and the maximum voltage of the signal after gain must be less than or equal to V_{REF}.

In code, changing the value to 0.44 gain from the previous example looks like:

```
// in 'C':
ADC0CF |= 0x01;          // GAINEN = 1
ADC0H = 0x04;            // Load the ADC0GNH address
ADC0L = 0x6C;            // Load the upper byte of 0x6CA to ADC0GNH
ADC0H = 0x07;            // Load the ADC0GNL address
ADC0L = 0xA0;            // Load the lower nibble of 0x6CA to ADC0GNL
ADC0H = 0x08;            // Load the ADC0GNA address
ADC0L = 0x01;            // Set the GAINADD bit
ADC0CF &= ~0x01;         // GAINEN = 0

; in assembly
ORL ADC0CF,#01H          ; GAINEN = 1
MOV ADC0H,#04H           ; Load the ADC0GNH address
MOV ADC0L,#06CH          ; Load the upper byte of 0x6CA to ADC0GNH
MOV ADC0H,#07H           ; Load the ADC0GNL address
MOV ADC0L,#0A0H          ; Load the lower nibble of 0x6CA to ADC0GNL
MOV ADC0H,#08H           ; Load the ADC0GNA address
MOV ADC0L,#01H           ; Set the GAINADD bit
ANL ADC0CF,#0FEH         ; GAINEN = 0
```

SFR Definition 7.1. REF0CN: Reference Control

Bit	7	6	5	4	3	2	1	0
Name			ZTCEN	REFLV	REFSL	TEMPE	BIASE	REFBE
Type	R	R	R	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xD1; SFR Page = 0x00

Bit	Name	Function
7:6	Unused	Read = 00b; Write = don't care.
5	ZTCEN	**Zero Temperature Coefficient Bias Enable Bit.** This bit must be set to 1b before entering oscillator suspend mode. 0: ZeroTC Bias Generator automatically enabled when required. 1: ZeroTC Bias Generator forced on.
4	REFLV	**Voltage Reference Output Level Select.** This bit selects the output voltage level for the internal voltage reference 0: Internal voltage reference set to 1.5 V. 1: Internal voltage reference set to 2.20 V.
3	REFSL	**Voltage Reference Select.** This bit selects the ADCs voltage reference. 0: V_{REF} pin used as voltage reference. 1: V_{DD} used as voltage reference. If V_{DD} is selected as the voltage reference and the ADC is enabled in the ADC0CN register, the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.
2	TEMPE	**Temperature Sensor Enable Bit.** 0: Internal Temperature Sensor off. 1: Internal Temperature Sensor on.
1	BIASE	**Internal Analog Bias Generator Enable Bit.** 0: Internal Bias Generator off. 1: Internal Bias Generator on.
0	REFBE	**On-chip Reference Buffer Enable Bit.** 0: On-chip Reference Buffer off. 1: On-chip Reference Buffer on. Internal voltage reference driven on the V_{REF} pin.

Notes on Registers, Operands and Addressing Modes:
Rn—Register R0–R7 of the currently selected register bank. **@Ri**—Data RAM location addressed indirectly through R0 or R1. **rel**—8-bit, signed (two's complement) offset relative to the first byte of the following instruction. Used by SJMP and all conditional jumps. **direct**—8-bit internal data location's address. This could be a direct-access Data RAM location (0x00–0x7F) or an SFR (0x80–0xFF). **#data**—8-bit constant **#data16**—16-bit constant **bit**—Direct-accessed bit in Data RAM or SFR **addr11**—11-bit destination address used by ACALL and AJMP. The destination must be within the same 2 kB page of program memory as the first byte of the following instruction. **addr16**—16-bit destination address used by LCALL and LJMP. The destination may be anywhere within the 64 kB program memory space. There is one unused opcode (0xA5) that performs the same function as NOP. All mnemonics copyrighted © Intel Corporation 1980.

10.3. CIP-51 Register Descriptions

Following are descriptions of SFRs related to the operation of the CIP-51 System Controller. Reserved bits should not be set to logic l. Future product versions may use these bits to implement new features in which case the reset value of the bit will be logic 0, selecting the feature's default state. Detailed descriptions of the remaining SFRs are included in the sections of the datasheet associated with their corresponding system function.

While in the CAN0 ISR, a PCA interrupt occurs. Recall the PCA interrupt is configured as a high priority interrupt, while the CAN0 interrupt is configured as a *low* priority interrupt. Thus, the CIP-51 will now vector to the high priority PCA ISR. Upon doing so, the CIP-51 will automatically place the SFR page needed to access the PCA's special function registers into the SFRPAGE register, SFR Page 0x00. The value that was in the SFRPAGE register before the PCA interrupt (SFR Page 0x0C for CAN0) is pushed down the stack into SFRNEXT. Likewise, the value that was in the SFRNEXT register before the PCA interrupt (in this case SFR Page 0x00 for SPI0DAT) is pushed down to the SFRLAST register, the "bottom" of the stack. Note that a value stored in SFRLAST (via a previous software write to the SFRLAST register) will be overwritten. See Figure 12.4.

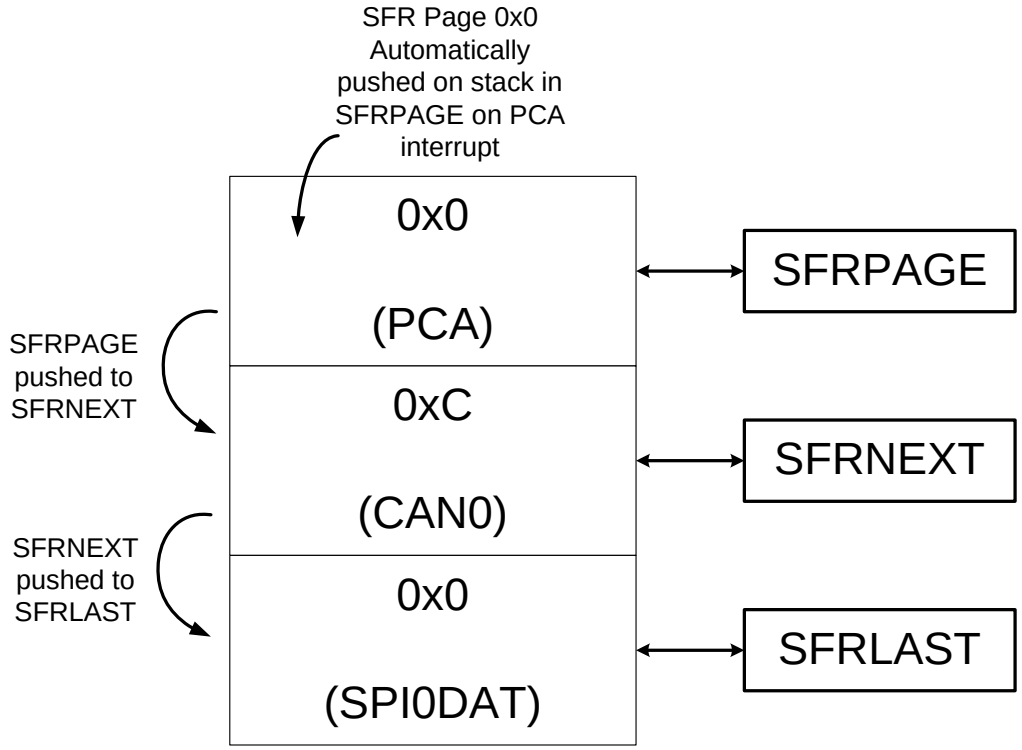

Figure 12.4. SFR Page Stack Upon PCA Interrupt Occurring During a CAN0 ISR

SFR Definition 13.4. EIP1: Extended Interrupt Priority 1

Bit	7	6	5	4	3	2	1	0
Name	PLIN0	PT3	PCP1	PCP0	PPCA0	PADC0	PWADC0	PSMB0
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF6; SFR Page = 0x00 and 0x0F

Bit	Name	Function
7	PLIN0	**LIN0 Interrupt Priority Control.** This bit sets the priority of the LIN0 interrupt. 0: LIN0 interrupts set to low priority level. 1: LIN0 interrupts set to high priority level.
6	PT3	**Timer 3 Interrupt Priority Control.** This bit sets the priority of the Timer 3 interrupt. 0: Timer 3 interrupts set to low priority level. 1: Timer 3 interrupts set to high priority level.
5	PCP1	**Comparator0 (CP1) Interrupt Priority Control.** This bit sets the priority of the CP1 interrupt. 0: CP1 interrupt set to low priority level. 1: CP1 interrupt set to high priority level.
4	PCP0	**Comparator0 (CP0) Interrupt Priority Control.** This bit sets the priority of the CP0 interrupt. 0: CP0 interrupt set to low priority level. 1: CP0 interrupt set to high priority level.
3	PPCA0	**Programmable Counter Array (PCA0) Interrupt Priority Control.** This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level.
2	PADC0	**ADC0 Conversion Complete Interrupt Priority Control.** This bit sets the priority of the ADC0 Conversion Complete interrupt. 0: ADC0 Conversion Complete interrupt set to low priority level. 1: ADC0 Conversion Complete interrupt set to high priority level.
1	PWADC0	**ADC0 Window Comparator Interrupt Priority Control.** This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level.
0	PSMB0	**SMBus (SMB0) Interrupt Priority Control.** This bit sets the priority of the SMB0 interrupt. 0: SMB0 interrupt set to low priority level. 1: SMB0 interrupt set to high priority level.

The level of Flash security depends on the Flash access method. The three Flash access methods that can be restricted are reads, writes, and erases from the C2 debug interface, user firmware executing on unlocked pages, and user firmware executing on locked pages. Table 14.1 summarizes the Flash security features of the C8051F55x/56x/57x devices.

Table 14.1. Flash Security Summary

Action	C2 Debug Interface	User Firmware executing from:	
		an unlocked page	a locked page
Read, Write or Erase unlocked pages (except page with Lock Byte)	Permitted	Permitted	Permitted
Read, Write or Erase locked pages (except page with Lock Byte)	Not Permitted	Flash Error Reset	Permitted
Read or Write page containing Lock Byte (if no pages are locked)	Permitted	Permitted	Permitted
Read or Write page containing Lock Byte (if any page is locked)	Not Permitted	Flash Error Reset	Permitted
Read contents of Lock Byte (if no pages are locked)	Permitted	Permitted	Permitted
Read contents of Lock Byte (if any page is locked)	Not Permitted	Flash Error Reset	Permitted
Erase page containing Lock Byte (if no pages are locked)	Permitted	Flash Error Reset	Flash Error Reset
Erase page containing Lock Byte—Unlock all pages (if any page is locked)	C2 Device Erase Only	Flash Error Reset	Flash Error Reset
Lock additional pages (change '1's to '0's in the Lock Byte)	Not Permitted	Flash Error Reset	Flash Error Reset
Unlock individual pages (change '0's to '1's in the Lock Byte)	Not Permitted	Flash Error Reset	Flash Error Reset
Read, Write or Erase Reserved Area	Not Permitted	Flash Error Reset	Flash Error Reset

C2 Device Erase—Erases all Flash pages including the page containing the Lock Byte.

Flash Error Reset—Not permitted; Causes Flash Error Device Reset (FERROR bit in RSTSRC is '1' after reset).

- All prohibited operations that are performed via the C2 interface are ignored (do not cause device reset).
- Locking any Flash page also locks the page containing the Lock Byte.
- Once written to, the Lock Byte cannot be modified except by performing a C2 Device Erase.
- If user code writes to the Lock Byte, the Lock does not take effect until the next device reset.

17.5.3. Split Mode with Bank Select

When EMI0CF[3:2] are set to 10, the XRAM memory map is split into two areas, on-chip space and off-chip space.

- Effective addresses below the internal XRAM size boundary will access on-chip XRAM space.
- Effective addresses above the internal XRAM size boundary will access off-chip space.
- 8-bit MOVX operations use the contents of EMI0CN to determine whether the memory access is on-chip or off-chip. The upper 8-bits of the Address Bus A[15:8] are determined by EMI0CN, and the lower 8-bits of the Address Bus A[7:0] are determined by R0 or R1. All 16-bits of the Address Bus A[15:0] are driven in “Bank Select” mode.
- 16-bit MOVX operations use the contents of DPTR to determine whether the memory access is on-chip or off-chip, and the full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.5.4. External Only

When EMI0CF[3:2] are set to 11, all MOVX operations are directed to off-chip space. On-chip XRAM is not visible to the CPU. This mode is useful for accessing off-chip memory located between 0x0000 and the internal XRAM size boundary.

- 8-bit MOVX operations ignore the contents of EMI0CN. The upper Address bits A[15:8] are not driven (identical behavior to an off-chip access in “Split Mode without Bank Select” described above). This allows the user to manipulate the upper address bits at will by setting the Port state directly. The lower 8-bits of the effective address A[7:0] are determined by the contents of R0 or R1.
- 16-bit MOVX operations use the contents of DPTR to determine the effective address A[15:0]. The full 16-bits of the Address Bus A[15:0] are driven during the off-chip transaction.

17.6. Timing

The timing parameters of the External Memory Interface can be configured to enable connection to devices having different setup and hold time requirements. The Address Setup time, Address Hold time, $\overline{RD}$ and $\overline{WR}$ strobe widths, and in multiplexed mode, the width of the ALE pulse are all programmable in units of SYSCLK periods through EMI0TC, shown in SFR Definition 17.3, and EMI0CF[1:0].

The timing for an off-chip MOVX instruction can be calculated by adding 4 SYSCLK cycles to the timing parameters defined by the EMI0TC register. Assuming non-multiplexed operation, the minimum execution time for an off-chip XRAM operation is 5 SYSCLK cycles (1 SYSCLK for $\overline{RD}$ or $\overline{WR}$ pulse + 4 SYSCLKs). For multiplexed operations, the Address Latch Enable signal will require a minimum of 2 additional SYSCLK cycles. Therefore, the minimum execution time for an off-chip XRAM operation in multiplexed mode is 7 SYSCLK cycles (2 for /ALE + 1 for $\overline{RD}$ or $\overline{WR}$ + 4). The programmable setup and hold times default to the maximum delay settings after a reset. Table 17.2 lists the ac parameters for the External Memory Interface, and Figure 17.3 through Figure 17.5 show the timing diagrams for the different External Memory Interface modes and MOVX operations.

17.6.1.3. 8-bit MOVX with Bank Select: EMI0CF[4:2] = 010

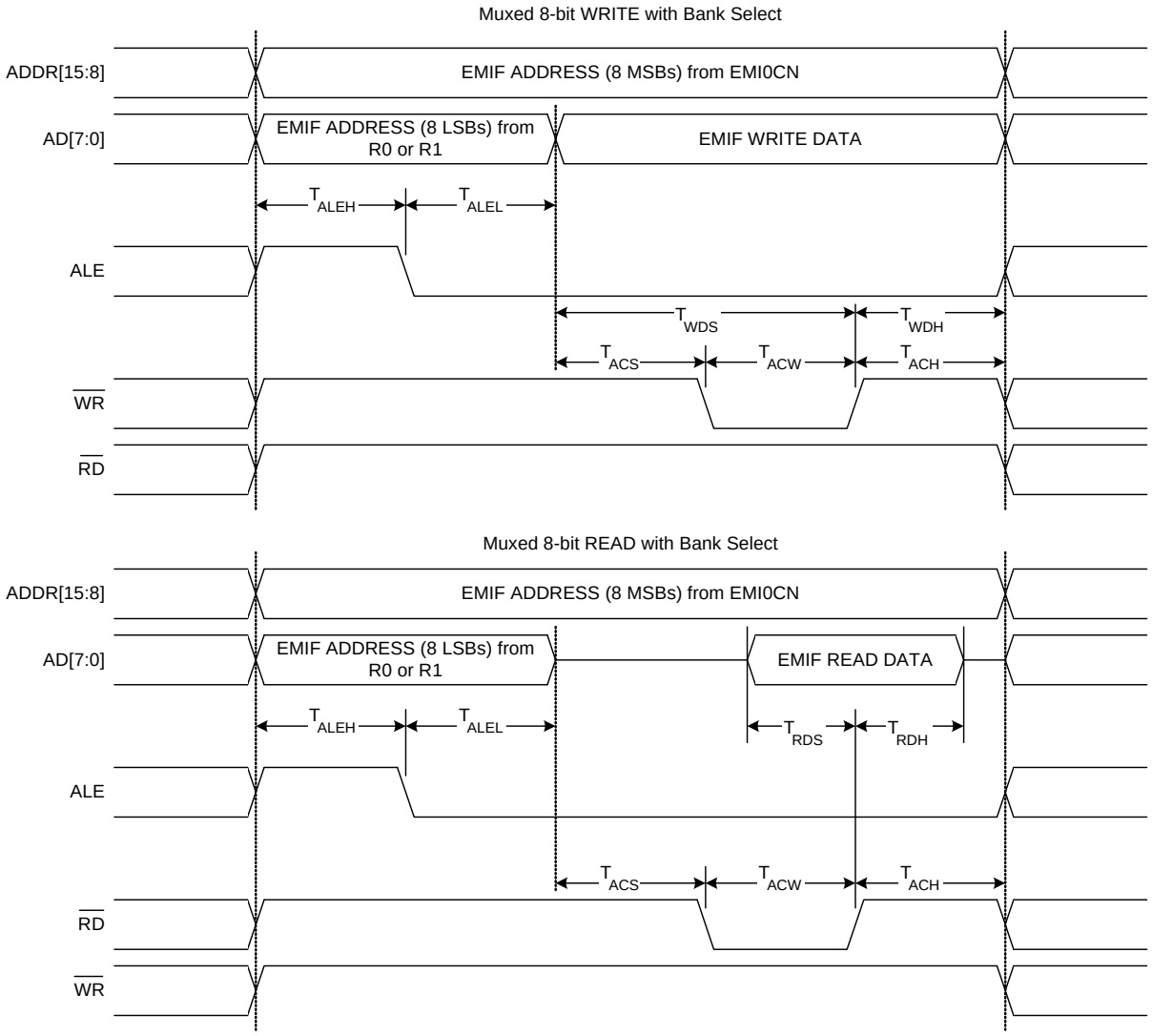

Figure 17.5. Multiplexed 8-bit MOVX with Bank Select Timing

SFR Definition 18.6. OSCXCN: External Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	XTLVLD	XOSCMD[2:0]				XFCN[2:0]		
Type	R	R/W			R	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9F; SFR Page = 0x0F

Bit	Name	Function
7	XTLVLD	**Crystal Oscillator Valid Flag.** (Read only when XOSCMD = 11x.) 0: Crystal Oscillator is unused or not yet stable. 1: Crystal Oscillator is running and stable.
6:4	XOSCMD[2:0]	**External Oscillator Mode Select.** 00x: External Oscillator circuit off. 010: External CMOS Clock Mode. 011: External CMOS Clock Mode with divide by 2 stage. 100: RC Oscillator Mode. 101: Capacitor Oscillator Mode. 110: Crystal Oscillator Mode. 111: Crystal Oscillator Mode with divide by 2 stage.
3	Unused	Read = 0b; Write =0b
2:0	XFCN[2:0]	**External Oscillator Frequency Control Bits.** Set according to the desired frequency for Crystal or RC mode. Set according to the desired K Factor for C mode.

XFCN	Crystal Mode	RC Mode	C Mode
000	f ≤ 32 kHz	f ≤ 25 kHz	K Factor = 0.87
001	32 kHz < f ≤ 84 kHz	25 kHz < f ≤ 50 kHz	K Factor = 2.6
010	84 kHz < f ≤ 225 kHz	50 kHz < f ≤ 100 kHz	K Factor = 7.7
011	225 kHz < f ≤ 590 kHz	100 kHz < f ≤ 200 kHz	K Factor = 22
100	590 kHz < f ≤ 1.5 MHz	200 kHz < f ≤ 400 kHz	K Factor = 65
101	1.5 MHz < f ≤ 4 MHz	400 kHz < f ≤ 800 kHz	K Factor = 180
110	4 MHz < f ≤ 10 MHz	800 kHz < f ≤ 1.6 MHz	K Factor = 664
111	10 MHz < f ≤ 30 MHz	1.6 MHz < f ≤ 3.2 MHz	K Factor = 1590

19. Port Input/Output

Digital and analog resources are available through 33 (C8051F568-9 and ‘F570-5), 25 (C8051F550-7) or 18 (C8051F550-7) I/O pins. Port pins P0.0-P4.0 on the C8051F568-9 and ‘F570-5, port pins P0.0-P3.0 on theC8051F560-7, and port pins P0.0-P2.1 on the C8051F550-7 can be defined as general-purpose I/O (GPIO), assigned to one of the internal digital resources, or assigned to an analog function as shown in Figure 19.3. Port pin P4.0 on the C8051F568-9 and ‘F570-5 can be used as GPIO and is shared with the C2 Interface Data signal (C2D). Similarly, port pin P3.0 is shared with C2D on the C8051F560-7 and port pin P2.1 on the C8051F550-7. The designer has complete control over which functions are assigned, limited only by the number of physical I/O pins. This resource assignment flexibility is achieved through the use of a Priority Crossbar Decoder. Note that the state of a Port I/O pin can always be read in the corresponding Port latch, regardless of the Crossbar settings.

The Crossbar assigns the selected internal digital resources to the I/O pins based on the Priority Decoder (Figure 19.3 and Figure 19.4). The registers XBR0, XBR1, XBR2 are defined in SFR Definition 19.1 and SFR Definition 19.2 and are used to select internal digital functions.

The Port I/O cells are configured as either push-pull or open-drain in the Port Output Mode registers (PnMDOUT, where n = 0,1). Complete Electrical Specifications for Port I/O are given in Table 5.3 on page 40.

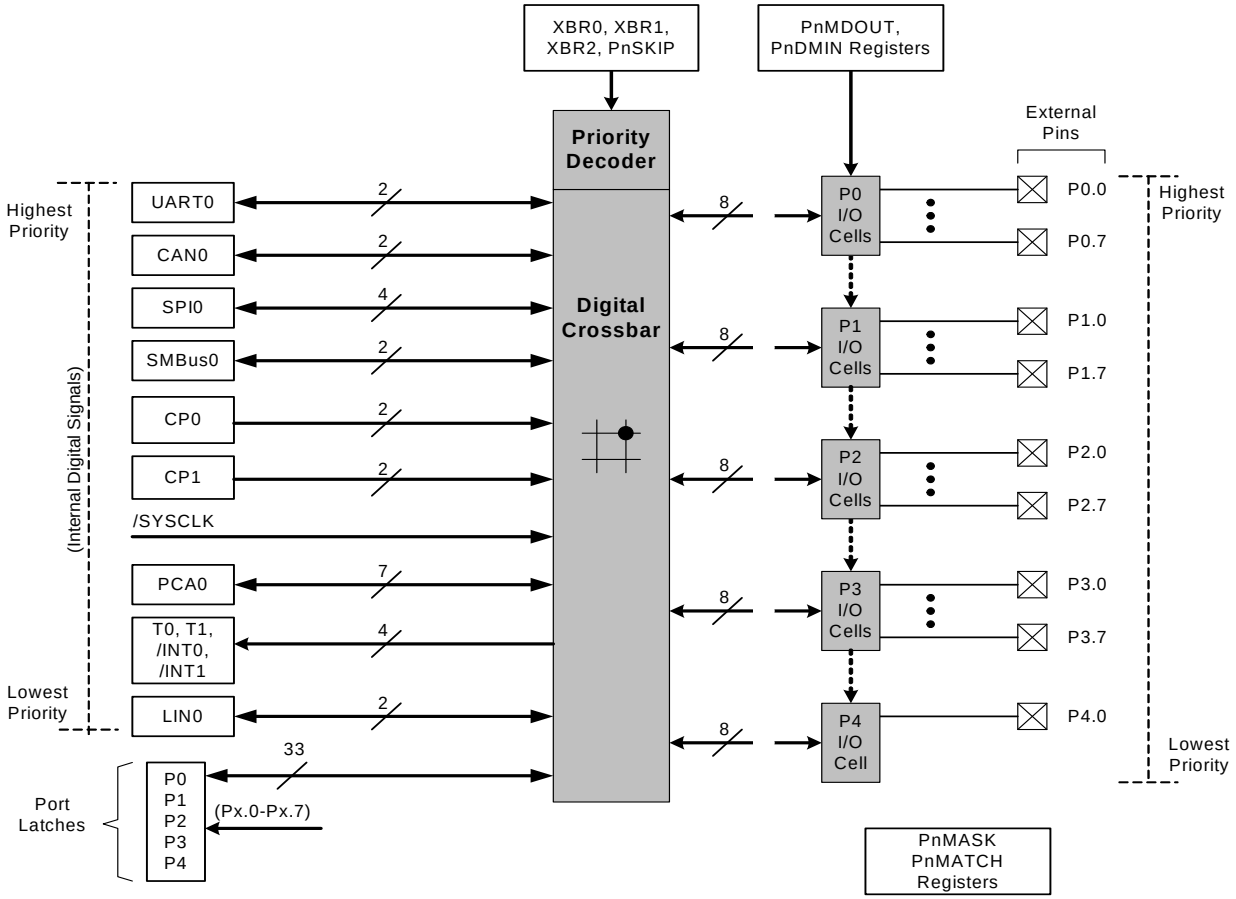

Figure 19.1. Port I/O Functional Block Diagram

SFR Definition 19.10. P3MASK: Port 3 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P3MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAF; SFR Page = 0x00

Bit	Name	Function
7:0	P3MASK[7:0]	**Port 1 Mask Value.** Selects P3 pins to be compared to the corresponding bits in P3MAT. 0: P3.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P3.n pin logic value is compared to P3MAT.n.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

SFR Definition 19.11. P3MAT: Port 3 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P3MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xAE; SFR Page = 0x00

Bit	Name	Function
7:0	P3MAT[7:0]	**Port 3 Match Value.** Match comparison value used on Port 3 for bits in P3MAT which are set to 1. 0: P3.n pin logic value is compared with logic LOW. 1: P3.n pin logic value is compared with logic HIGH.
Note: P3.0 is available on 40-pin and 32-pin packages. P3.1-P3.7 are available on 40-pin packages		

Table 20.2. Manual Baud Rate Parameters Examples

	Baud (bits/sec)														
	20 K			19.2 K			9.6 K			4.8 K			1 K		
SYSCLK (MHz)	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.
25	0	1	312	0	1	325	1	1	325	3	1	325	19	1	312
24.5	0	1	306	0	1	319	1	1	319	3	1	319	19	1	306
24	0	1	300	0	1	312	1	1	312	3	1	312	19	1	300
22.1184	0	1	276	0	1	288	1	1	288	3	1	288	19	1	276
16	0	1	200	0	1	208	1	1	208	3	1	208	19	1	200
12.25	0	0	306	0	0	319	1	0	319	3	0	319	19	0	306
12	0	0	300	0	0	312	1	0	312	3	0	312	19	0	300
11.0592	0	0	276	0	0	288	1	0	288	3	0	288	19	0	276
8	0	0	200	0	0	208	1	0	208	3	0	208	19	0	200

20.2.4. Baud Rate Calculations—Automatic Mode

If the LIN controller is configured for slave mode, only the prescaler and divider need to be calculated:

$$\text{prescaler} = \ln\left[\frac{\text{SYSCLK}}{4000000}\right] \times \frac{1}{\ln 2} - 1$$

$$\text{divider} = \frac{\text{SYSCLK}}{2^{(\text{prescaler}+1)} \times 20000}$$

The following example calculates the values of these variables for a 24 MHz system clock:

$$\text{prescaler} = \ln\left[\frac{24000000}{4000000}\right] \times \frac{1}{\ln 2} - 1 = 1.585 \cong 1$$

$$\text{divider} = \frac{24000000}{2^{(1+1)} \times 20000} = 300$$

Table 20.3 presents some typical values of system clock and baud rate along with their factors.

LIN Register Definition 20.5. LIN0CTRL: LIN0 Control Register

Bit	7	6	5	4	3	2	1	0
Name	STOP	SLEEP	TXRX	DTACK	RSTINT	RSTERR	WUPREQ	STREQ
Type	W	R/W	R/W	R/W	W	W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x08

Bit	Name	Function
7	STOP	**Stop Communication Processing Bit. (slave mode only)** This bit always reads as 0. 0: No effect. 1: Block the processing of LIN communications until the next SYNC BREAK signal.
6	SLEEP	**Sleep Mode Bit. (slave mode only)** 0: Wake the device after receiving a Wakeup interrupt. 1: Put the device into sleep mode after receiving a Sleep Mode frame or a bus idle timeout.
5	TXRX	**Transmit / Receive Selection Bit.** 0: Current frame is a receive operation. 1: Current frame is a transmit operation.
4	DTACK	**Data Acknowledge Bit. (slave mode only)** Set to 1 after handling a data request interrupt to acknowledge the transfer. The bit will automatically be cleared to 0 by the LIN controller.
3	RSTINT	**Reset Interrupt Bit.** This bit always reads as 0. 0: No effect. 1: Reset the LININT bit (LIN0ST.3).
2	RSTERR	**Reset Error Bit.** This bit always reads as 0. 0: No effect. 1: Reset the error bits in LIN0ST and LIN0ERR.
1	WUPREQ	**Wakeup Request Bit.** Set to 1 to terminate sleep mode by sending a wakeup signal. The bit will automatically be cleared to 0 by the LIN controller.
0	STREQ	**Start Request Bit. (master mode only)** 1: Start a LIN transmission. This should be set only after loading the identifier, data length and data buffer if necessary. The bit is reset to 0 upon transmission completion or error detection.

21.2.4. CAN Register Assignment

The standard Bosch CAN registers are mapped to SFR space as shown below and their full definitions are available in the CAN User's Guide. The name shown in the Name column matches what is provided in the CAN User's Guide. One additional SFR which is not a standard Bosch CAN register, CAN0CFG, is provided to configure the CAN clock. All CAN registers are located on SFR Page 0x0C.

Table 21.2. Standard CAN Registers and Reset Values

CAN Addr.	Name	SFR Name (High)	SFR Addr.	SFR Name (Low)	SFR Addr.	16-bit SFR	Reset Value
0x00	CAN Control Register	—	—	CAN0CN	0xC0	—	0x01
0x02	Status Register	—	—	CAN0STAT	0x94	—	0x00
0x04	Error Counter[1]	CAN0ERRH	0x97	CAN0ERRL	0x96	CAN0ERR	0x0000
0x06	Bit Timing Register[2]	CAN0BTH	0x9B	CAN0BTL	0x9A	CAN0BT	0x2301
0x08	Interrupt Register[1]	CAN0IIDH	0x9D	CAN0IIDL	0x9C	CAN0IID	0x0000
0x0A	Test Register	—	—	CAN0TST	0x9E	—	0x00[3,4]
0x0C	BRP Extension Register[2]	—	—	CAN0BRPE	0xA1	—	0x00
0x10	IF1 Command Request	CAN0IF1CRH	0xBF	CAN0IF1CRL	0xBE	CAN0IF1CR	0x0001
0x12	IF1 Command Mask	CAN0IF1CMH	0xC3	CAN0IF1CML	0xC2	CAN0IF1CM	0x0000
0x14	IF1 Mask 1	CAN0IF1M1H	0xC5	CAN0IF1M1L	0xC4	CAN0IF1M1	0xFFFF
0x16	IF1 Mask 2	CAN0IF1M2H	0xC7	CAN0IF1M2L	0xC6	CAN0IF1M2	0xFFFF
0x18	IF1 Arbitration 1	CAN0IF1A1H	0xCB	CAN0IF1A1L	0xCA	CAN0IF1A1	0x0000
0x1A	IF1 Arbitration 2	CAN0IF1A2H	0xCD	CAN0IF1A2L	0xCC	CAN0IF1A2	0x0000
0x1C	IF1 Message Control	CAN0IF1MCH	0xD3	CAN0IF1MCL	0xD2	CAN0IF1MC	0x0000
0x1E	IF1 Data A 1	CAN0IF1DA1H	0xD5	CAN0IF1DA1L	0xD4	CAN0IF1DA1	0x0000
0x20	IF1 Data A 2	CAN0IF1DA2H	0xD7	CAN0IF1DA2L	0xD6	CAN0IF1DA2	0x0000
0x22	IF1 Data B 1	CAN0IF1DB1H	0xDB	CAN0IF1DB1L	0xDA	CAN0IF1DB1	0x0000
0x24	IF1 Data B 2	CAN0IF1DB2H	0xDD	CAN0IF1DB2L	0xDC	CAN0IF1DB2	0x0000
0x40	IF2 Command Request	CAN0IF2CRH	0xDF	CAN0IF2CRL	0xDE	CAN0IF2CR	0x0001
0x42	IF2 Command Mask	CAN0IF2CMH	0xE3	CAN0IF2CML	0xE2	CAN0IF2CM	0x0000
0x44	IF2 Mask 1	CAN0IF2M1H	0xEB	CAN0IF2M1L	0xEA	CAN0IF2M1	0xFFFF
0x46	IF2 Mask 2	CAN0IF2M2H	0xED	CAN0IF2M2L	0xEC	CAN0IF2M2	0xFFFF
0x48	IF2 Arbitration 1	CAN0IF2A1H	0xEF	CAN0IF2A1L	0xEE	CAN0IF2A1	0x0000
0x4A	IF2 Arbitration 2	CAN0IF2A2H	0xF3	CAN0IF2A2L	0xF2	CAN0IF2A2	0x0000
0x4C	IF2 Message Control	CAN0IF2MCH	0xCF	CAN0IF2MCL	0xCE	CAN0IF2MC	0x0000
0x4E	IF2 Data A 1	CAN0IF2DA1H	0xF7	CAN0IF2DA1L	0xF6	CAN0IF2DA1	0x0000

Notes:
1. Read-only register.
2. Write-enabled by CCE.
3. The reset value of CAN0TST could also be r0000000b, where r signifies the value of the CAN RX pin.
4. Write-enabled by Test.

22.5.4. Read Sequence (Slave)

During a read sequence, an SMBus master reads data from a slave device. The slave in this transfer will be a receiver during the address byte, and a transmitter during all data bytes. When slave events are enabled (INH = 0), the interface enters Slave Receiver Mode (to receive the slave address) when a START followed by a slave address and direction bit (READ in this case) is received. Upon entering Slave Receiver Mode, an interrupt is generated and the ACKRQ bit is set. The software must respond to the received slave address with an ACK, or ignore the received slave address with a NACK. The interrupt will occur after the ACK cycle.

If the received slave address is ignored, slave interrupts will be inhibited until the next START is detected. If the received slave address is acknowledged, zero or more data bytes are transmitted. If the received slave address is acknowledged, data should be written to SMB0DAT to be transmitted. The interface enters Slave Transmitter Mode, and transmits one or more bytes of data. After each byte is transmitted, the master sends an acknowledge bit; if the acknowledge bit is an ACK, SMB0DAT should be written with the next data byte. If the acknowledge bit is a NACK, SMB0DAT should not be written to before SI is cleared (Note: an error condition may be generated if SMB0DAT is written following a received NACK while in Slave Transmitter Mode). The interface exits Slave Transmitter Mode after receiving a STOP. Note that the interface will switch to Slave Receiver Mode if SMB0DAT is not written following a Slave Transmitter interrupt. Figure 22.8 shows a typical slave read sequence. Two transmitted data bytes are shown, though any number of bytes may be transmitted. Notice that all of the ‘data byte transferred’ interrupts occur **after** the ACK cycle in this mode.

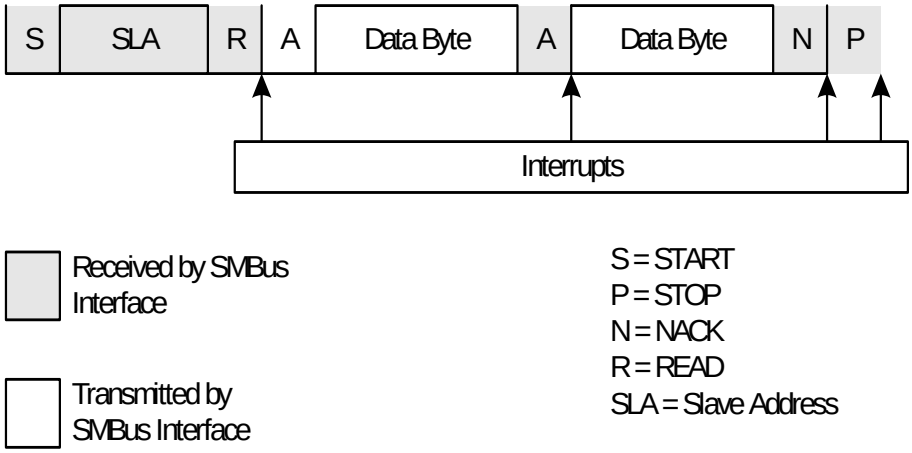

Figure 22.8. Typical Slave Read Sequence

22.6. SMBus Status Decoding

The current SMBus status can be easily decoded using the SMB0CN register. In the tables, STATUS VECTOR refers to the four upper bits of SMB0CN: MASTER, TXMODE, STA, and STO. The shown response options are only the typical responses; application-specific procedures are allowed as long as they conform to the SMBus specification. Highlighted responses are allowed by hardware but do not conform to the SMBus specification.

24.5. Serial Clock Phase and Polarity

Four combinations of serial clock phase and polarity can be selected using the clock control bits in the SPI0 Configuration Register (SPI0CFG). The CKPHA bit (SPI0CFG.5) selects one of two clock phases (edge used to latch the data). The CKPOL bit (SPI0CFG.4) selects between an active-high or active-low clock. Both master and slave devices must be configured to use the same clock phase and polarity. SPI0 should be disabled (by clearing the SPIEN bit, SPI0CN.0) when changing the clock phase or polarity. The clock and data line relationships for master mode are shown in Figure 24.5. For slave mode, the clock and data relationships are shown in Figure 24.6 and Figure 24.7. CKPHA must be set to 0 on both the master and slave SPI when communicating between two of the following devices: C8051F04x, C8051F06x, C8051F12x, C8051F31x, C8051F32x, and C8051F33x.

The SPI0 Clock Rate Register (SPI0CKR) as shown in SFR Definition 24.3 controls the master mode serial clock frequency. This register is ignored when operating in slave mode. When the SPI is configured as a master, the maximum data transfer rate (bits/sec) is one-half the system clock frequency or 12.5 MHz, whichever is slower. When the SPI is configured as a slave, the maximum data transfer rate (bits/sec) for full-duplex operation is 1/10 the system clock frequency, provided that the master issues SCK, NSS (in 4-wire slave mode), and the serial input data synchronously with the slave's system clock. If the master issues SCK, NSS, and the serial input data asynchronously, the maximum data transfer rate (bits/sec) must be less than 1/10 the system clock frequency. In the special case where the master only wants to transmit data to the slave and does not need to receive data from the slave (i.e. half-duplex operation), the SPI slave can receive data at a maximum data transfer rate (bits/sec) of 1/4 the system clock frequency. This is provided that the master issues SCK, NSS, and the serial input data synchronously with the slave's system clock.

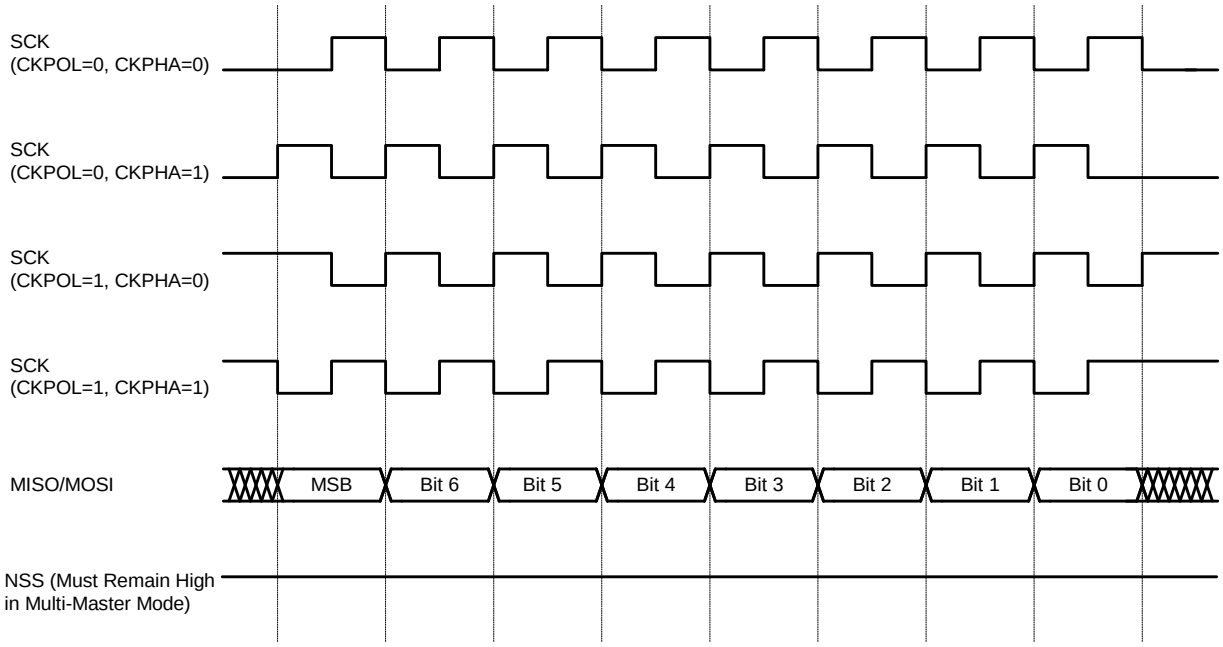

Figure 24.5. Master Mode Data/Clock Timing

NOTES: